

RELIABILITY MONITOR

PRODUCT	MONITOR DATE	DATE CODE	ASSEMBLY FACILITY	ASSEMBLY LOT NO	PROCESS TYPE	PACKAGE TYPE
DS1230Y	Oct-96	9635 M	DALLAS	DA084252	N/A	28 MODULE

STRESS/JOB NO.

**READPOINT
(Sample Size/No. of Fails)**

Storage Life
85°C, No Bias
P-18332

48 Hr Cum %
200/0 0.0%

Temp Cycle
0°C to +70°C
P-18372

300 ~ 1K ~ Cum %

Moisture Soak
60°C/90% RH
P-18373

288 Hr 960 Hr Cum %
100/0 100/0 0.0%

Phys. Dimen.
P-18331
6/0

Solderability
P-18330
24/5
F1

Failure Mode

F1: 5-Dewetting/nonwetting

Failure Analysis

In process